

# Insulated Gate Bi-Polar Transistor

## Type T0258HF65G

### Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V <sub>CES</sub>	Collector – emitter voltage	6500	V
V <sub>CES</sub>	Collector – emitter voltage (T <sub>j</sub> 25°C)	6500	V
V <sub>CES</sub>	Collector – emitter voltage (T <sub>j</sub> -40°C)	6000	V
V <sub>DC link</sub>	Permanent DC voltage for 100 FIT failure rate.	3600	V
V <sub>GES</sub>	Peak gate – emitter voltage	±20	V

	RATINGS	MAXIMUM LIMITS	UNITS
I <sub>C</sub>	DC collector current, IGBT	258	A
I <sub>CRM</sub>	Repetitive peak collector current, t <sub>p</sub> =1ms, IGBT	516	A
I <sub>F(DC)</sub>	Continuous DC forward current, Diode	258	A
I <sub>FRM</sub>	Repetitive peak forward current, t <sub>p</sub> =1ms, Diode	516	A
I <sub>FSM</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>RM</sub> =60%V <sub>RRM</sub> , Diode (Note 4)	2110	A
I <sub>FSM2</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>RM</sub> ≤10V, Diode (Note 4)	2320	A
P <sub>MAX</sub>	Maximum power dissipation, IGBT (Note 2)	3	KW
(di/dt) <sub>cr</sub>	Critical diode di/dt (note 3)	1000	A/μs
T <sub>j</sub>	Operating temperature range.	-40 to +125	°C
T <sub>stg</sub>	Storage temperature range.	-40 to +125	°C

Notes: -

- 1) Unless otherwise indicated T<sub>j</sub> = 125°C.
- 2) T<sub>sink</sub> = 25°C, double side cooled.
- 3) Maximum commutation loop inductance 1000nH.
- 4) Half-sinewave, 125°C T<sub>j</sub> initial.

## Characteristics

### IGBT Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V <sub>CE(sat)</sub>	Collector – emitter saturation voltage	-	3.6	-	I <sub>C</sub> = 258A, V <sub>GE</sub> = 15V, T <sub>j</sub> = 25°C	V
		4.4	4.8	5.2	I <sub>C</sub> = 258A, V <sub>GE</sub> = 15V	V
V <sub>T0</sub>	Threshold voltage	-		2.49	Current range: 86A – 258A	V
r <sub>T</sub>	Slope resistance	-		10.5		mΩ
V <sub>GE(TH)</sub>	Gate threshold voltage	-	5.2	-	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 258mA	V
I <sub>CES</sub>	Collector – emitter cut-off current	-	2.5	10	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V	mA
I <sub>GES</sub>	Gate leakage current	-	-	20	V <sub>GE</sub> = ±20V	μA
C <sub>ies</sub>	Input capacitance	-	45	-	V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0V, f = 100kHz, T <sub>j</sub> =25°C	nF
t <sub>d(on)</sub>	Turn-on delay time	-	1.7	-	I <sub>C</sub> = 258A, V <sub>CE</sub> = 3600V, di/dt = 700A/μs	μs
t <sub>r(V)</sub>	Rise time	-	3.5	-		μs
Q <sub>g(on)</sub>	Turn-on gate charge	-	1.5	-	V <sub>GE</sub> = ±15V, L <sub>S</sub> = 1000nH	μC
E <sub>on</sub>	Turn-on energy	-	1.8	-	R <sub>g(ON)</sub> = 12Ω, R <sub>g(OFF)</sub> = 36Ω, C <sub>GE</sub> = 22nF	J
t <sub>d(off)</sub>	Turn-off delay time	-	5.0	-	Integral diode used as freewheel diode (Note 3 & 4)	μs
t <sub>f(l)</sub>	Fall time	-	2.2	-		μs
Q <sub>g(off)</sub>	Turn-off gate charge	-	2.5	-		μC
E <sub>off</sub>	Turn-off energy	-	1.45	-		J
I <sub>sc</sub>	Short circuit current	-	1400	-	V <sub>GE</sub> = +15V, V <sub>CC</sub> = 3600V, V <sub>CEmax</sub> ≤ V <sub>CES</sub> , t <sub>p</sub> ≤ 10μs	A

### Diode Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V <sub>F</sub>	Forward voltage	-	3.1	-	I <sub>F</sub> = 258A, T <sub>j</sub> = 25°C	V
		-	3.45	3.85	I <sub>F</sub> = 258A	V
V <sub>To</sub>	Threshold voltage	-	-	1.89	Current range 86A – 258A	V
r <sub>T</sub>	Slope resistance	-	-	7.6		mΩ
I <sub>rm</sub>	Peak reverse recovery current	-	300	-	V <sub>F</sub> = 3600V, I <sub>F</sub> = 258A, V <sub>GE</sub> = -15V, di/dt = 700A/μs	A
Q <sub>rr</sub>	Recovered charge	-	410	-		μC
t <sub>rr</sub>	Reverse recovery time, 50% chord	-	1.2	-		μs
E <sub>r</sub>	Reverse recovery energy	-	0.6	-		J

### Thermal Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
R <sub>thJK</sub>	Thermal resistance junction to sink, IGBT	-	-	32.8	Double side cooled	K/kW
		-	-	49.4	Collector side cooled	K/kW
		-	-	98	Emitter side cooled	K/kW
R <sub>thJK</sub>	Thermal resistance junction to sink, Diode	-	-	56.7	Double side cooled	K/kW
		-	-	82	Cathode side cooled	K/kW
		-	-	183	Anode side cooled	K/kW
F	Mounting force	12	-	16	Note 2	kN
W <sub>t</sub>	Weight	-	825	-		g

Notes:-

- 1) Unless otherwise indicated T<sub>j</sub> = 125°C.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C<sub>GE</sub> is additional gate – emitter capacitance added to output of gate drive
- 4) Figures 6 to 9 are obtained using integral diode as freewheeling diode

**Curves**

Figure 1 – Typical collector-emitter saturation voltage characteristics

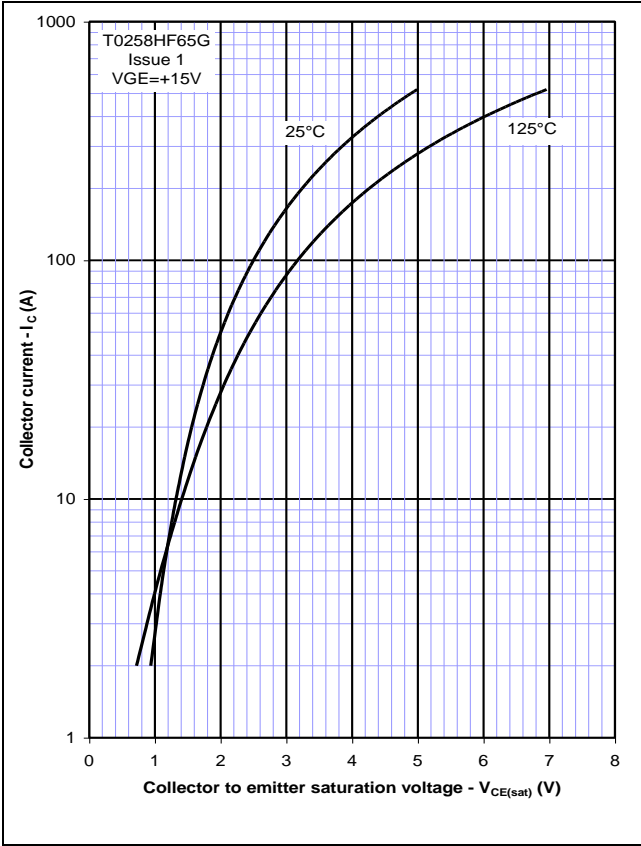


Figure 2 – Typical output characteristic

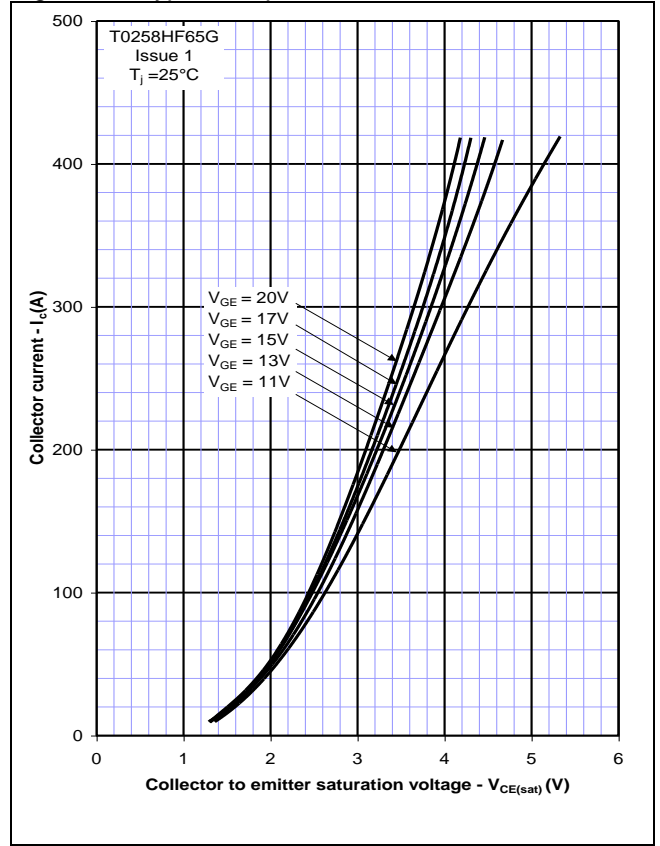


Figure 3 – Typical output characteristic

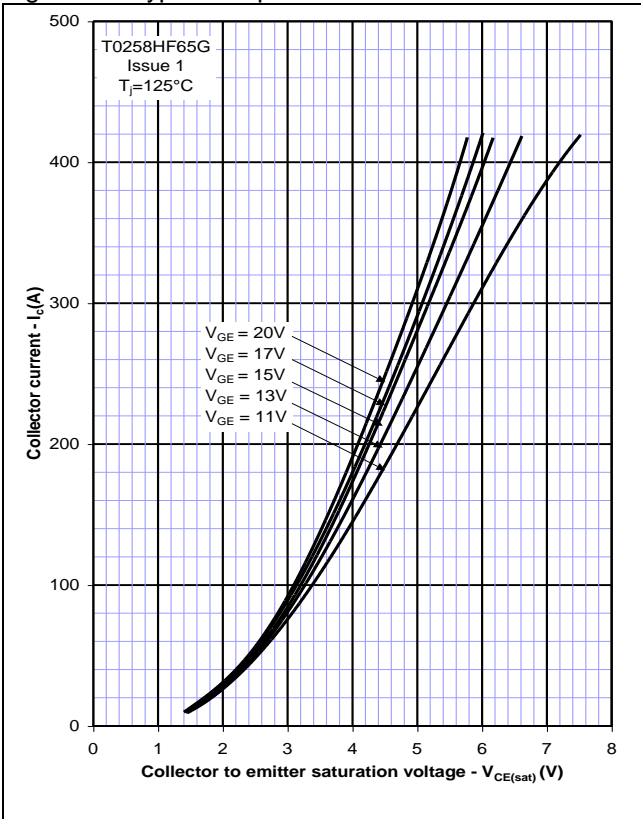


Figure 4 – Typical turn-on delay time vs gate resistance

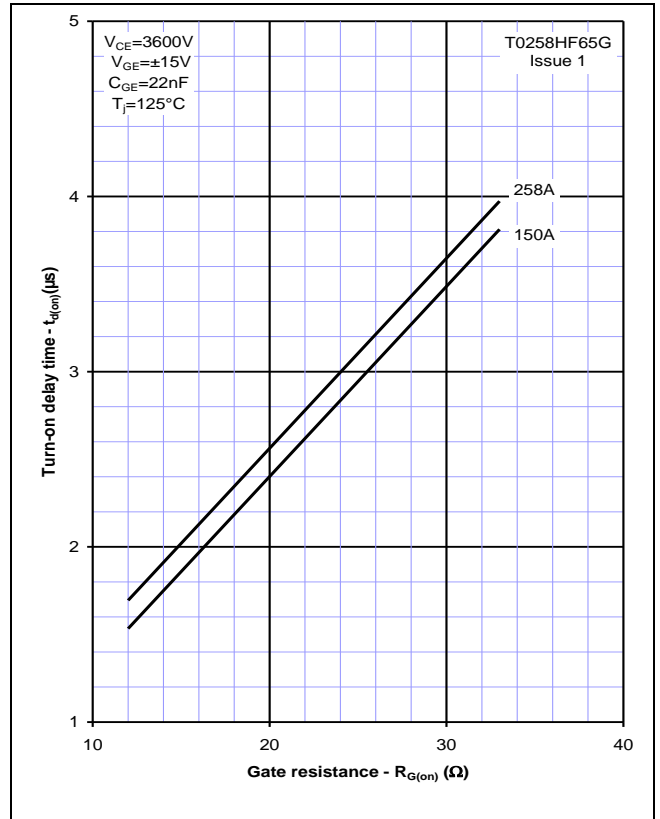


Figure 5 – Typical turn-off delay time vs. gate resistance

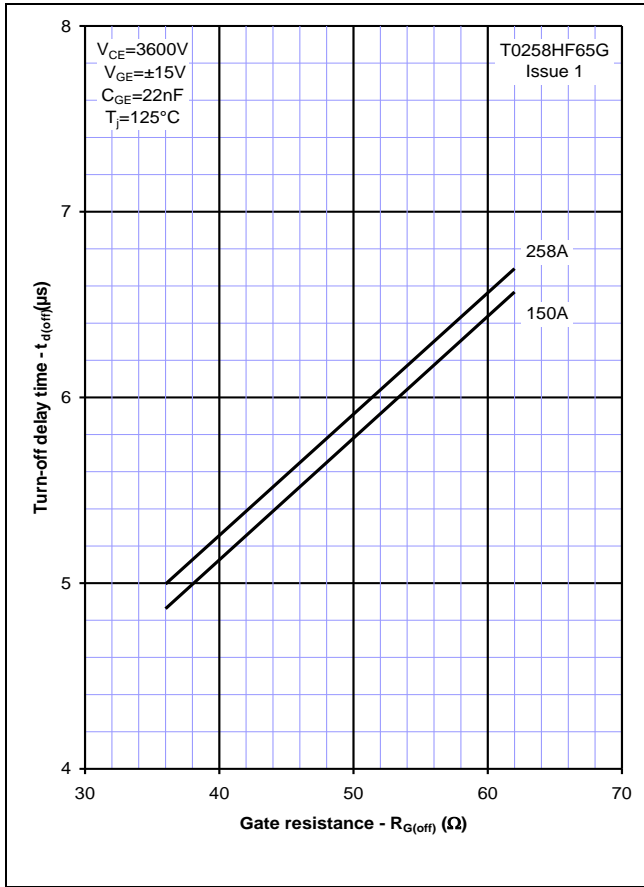


Figure 6 – Typical turn-on energy vs. collector current

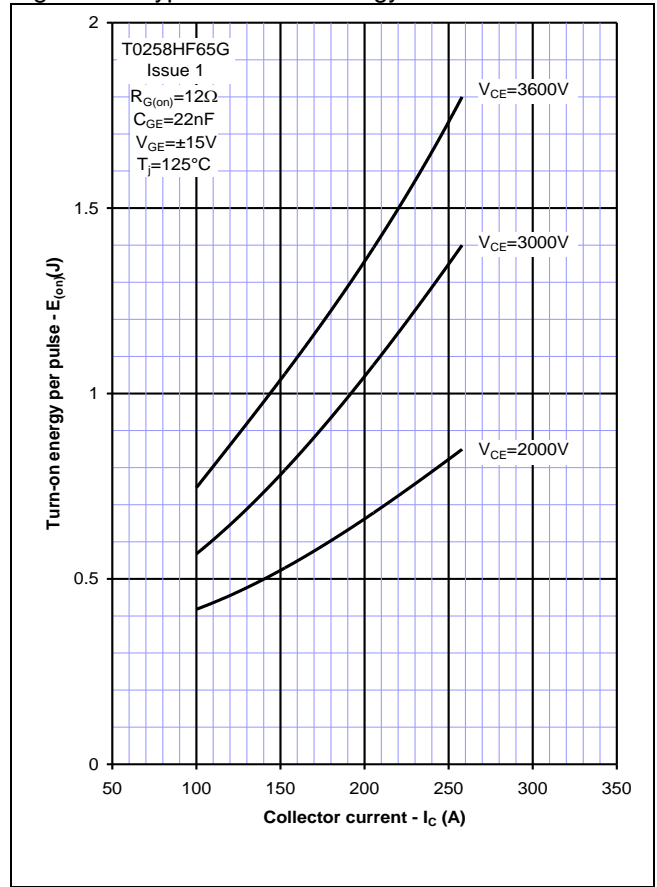


Figure 7 – Typical turn-on energy vs. di/dt

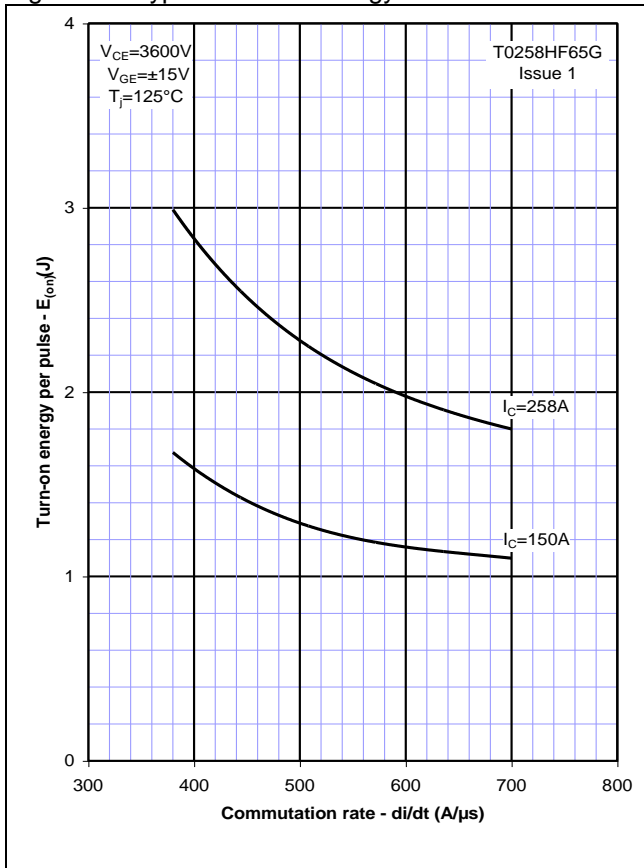


Figure 8 – Typical turn-off energy vs. collector current

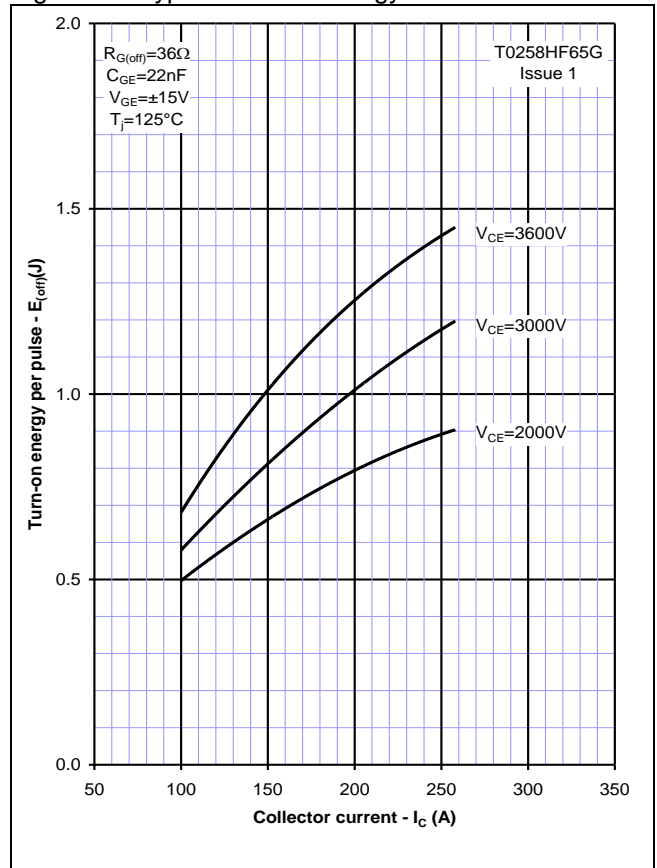


Figure 9 – Turn-off energy vs voltage

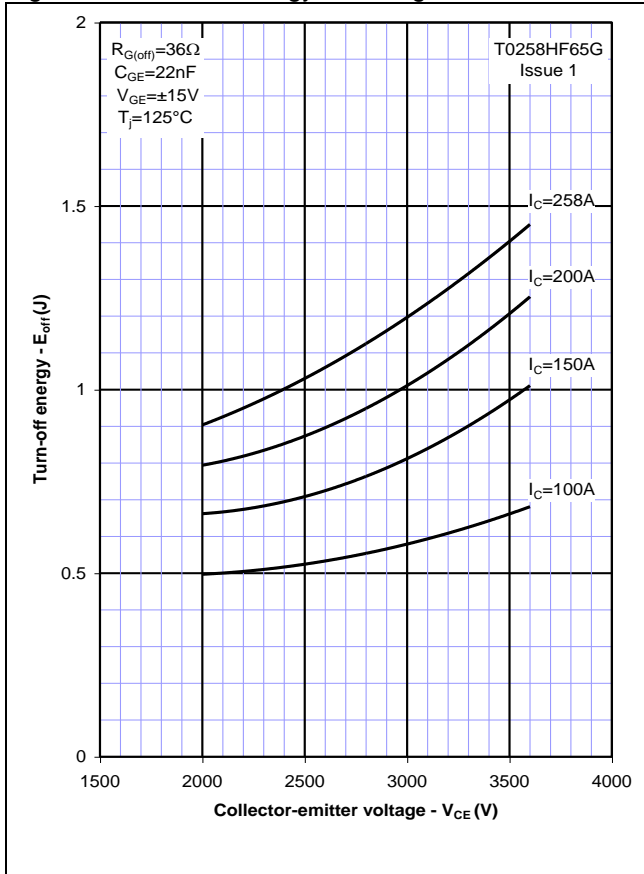


Figure 10 – Safe operating area (IGBT)

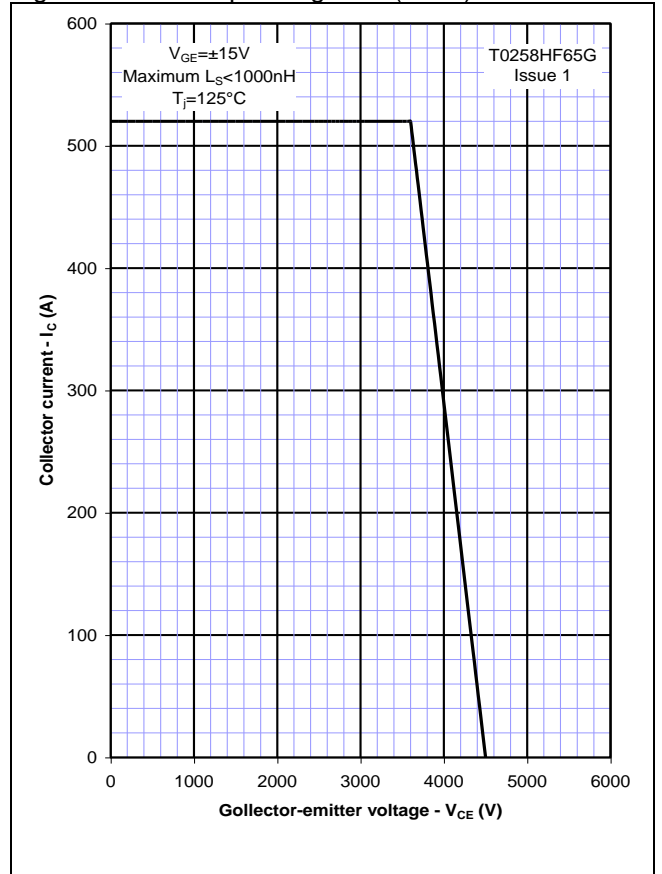


Figure 11 – Typical diode forward characteristics

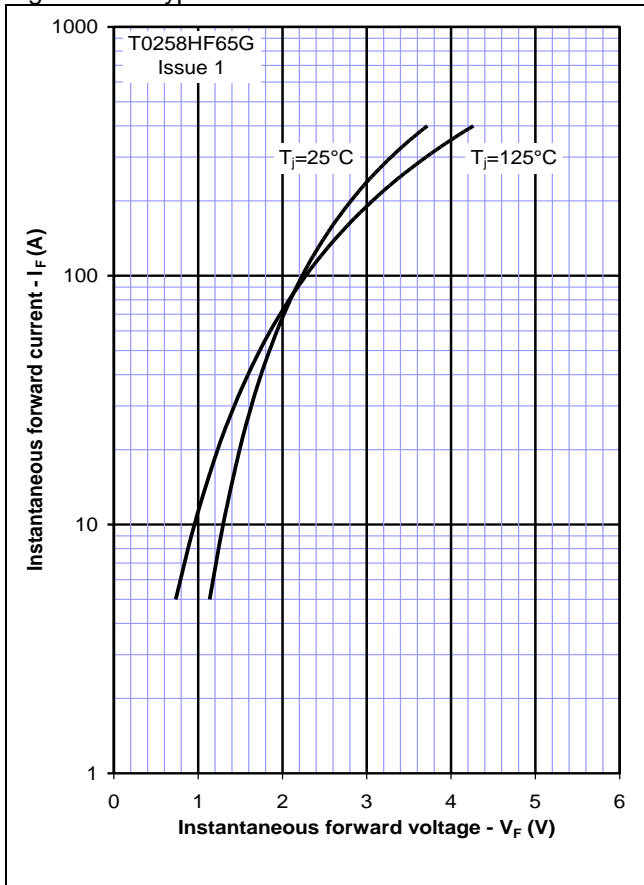


Figure 12 – Typical recovered charge

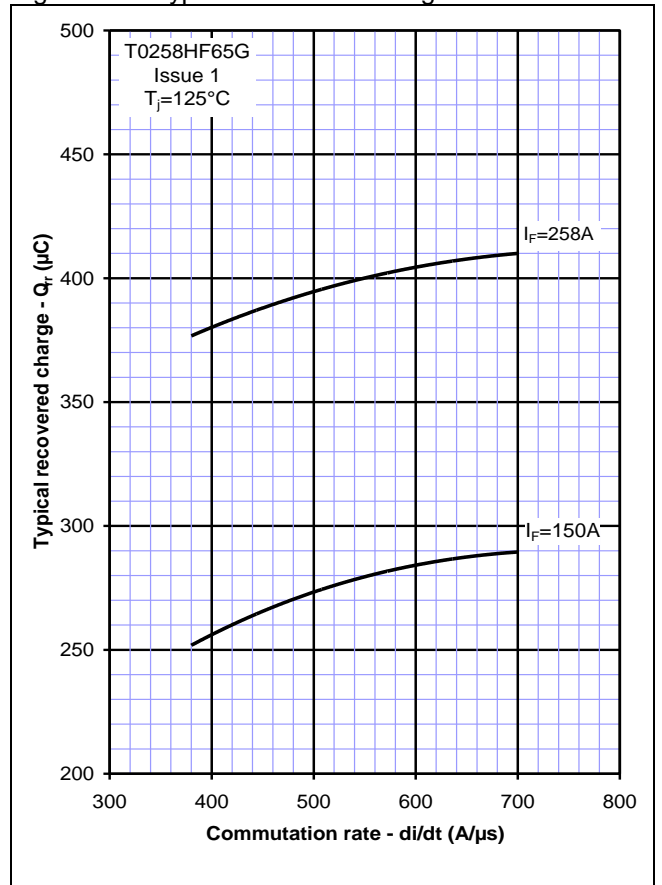


Figure 13 – Typical reverse recovery current

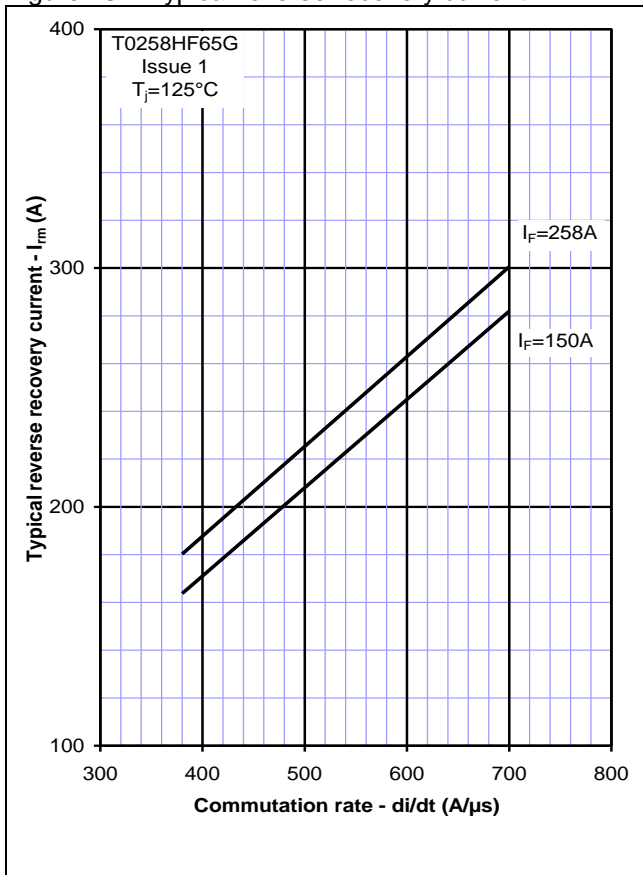


Figure 14 – Typical reverse recovery time

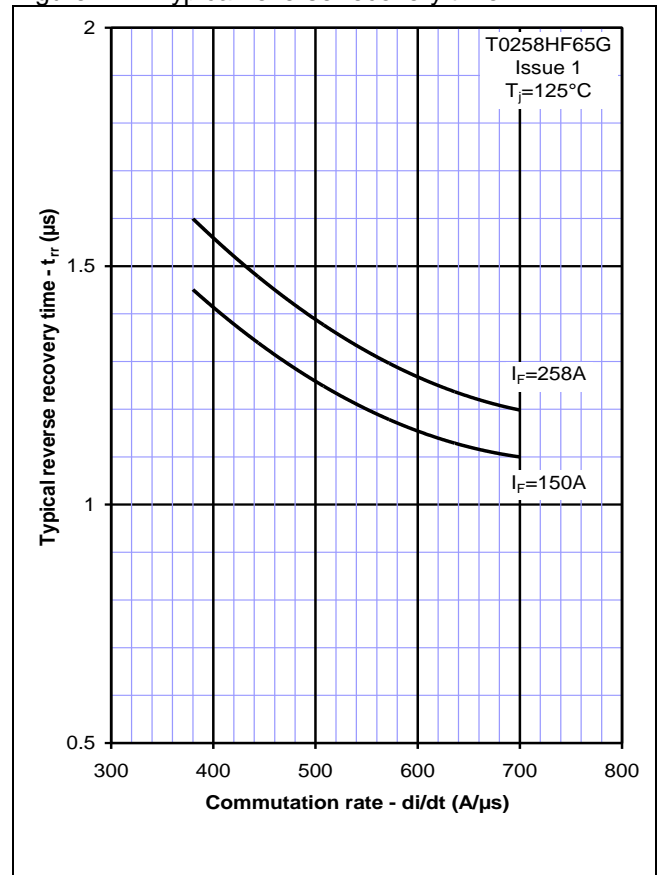


Figure 15 – Typical reverse recovery energy

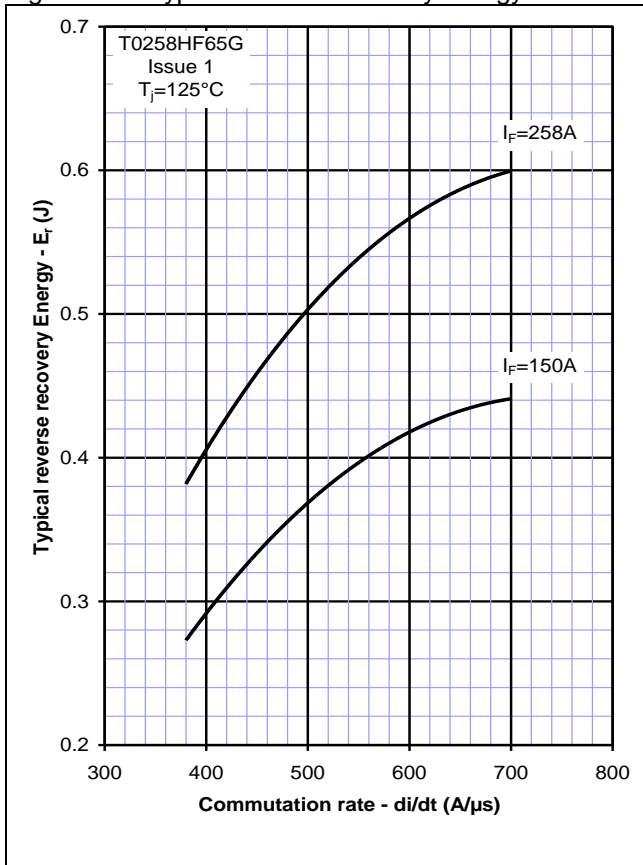


Figure 16 – Safe operating area (Diode)

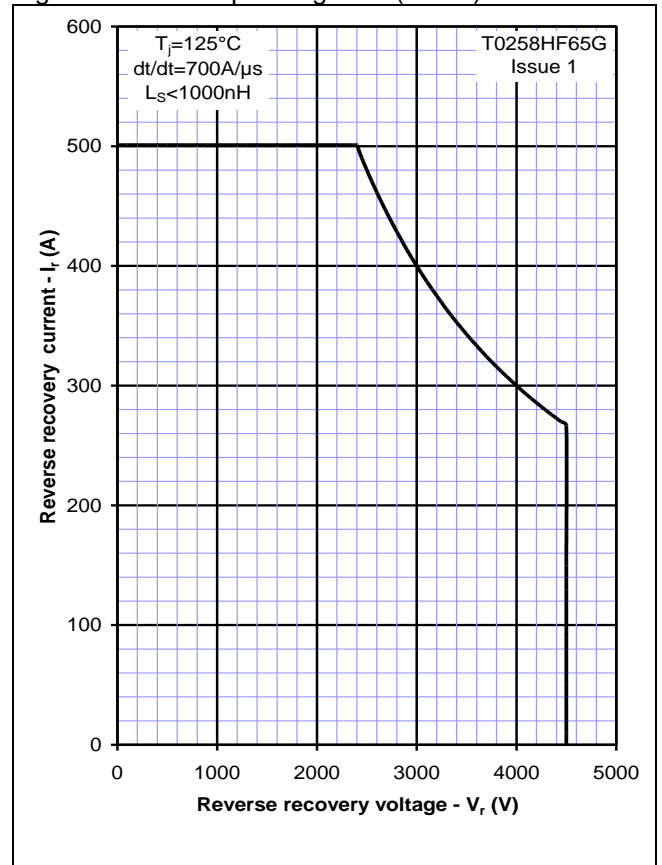


Figure 17 – Transient thermal impedance (IGBT)

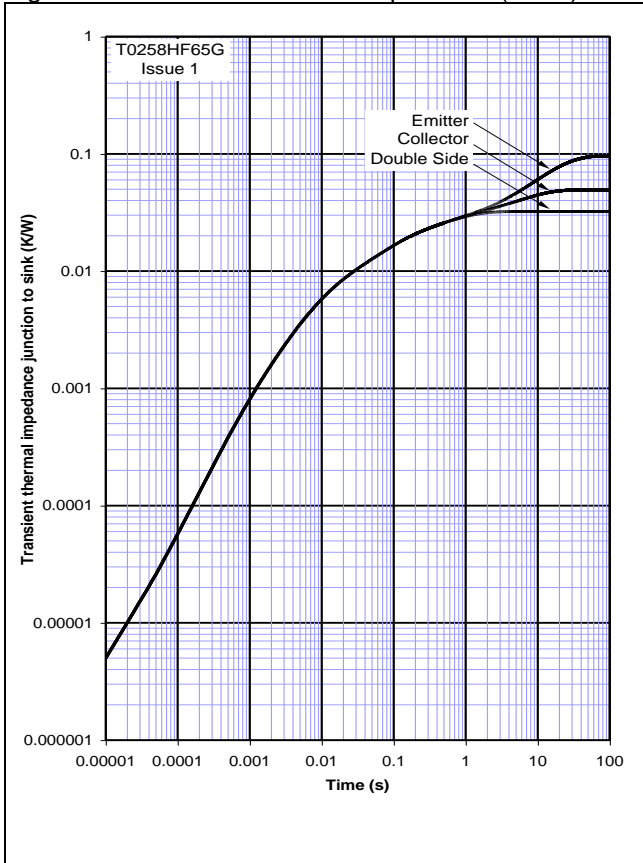
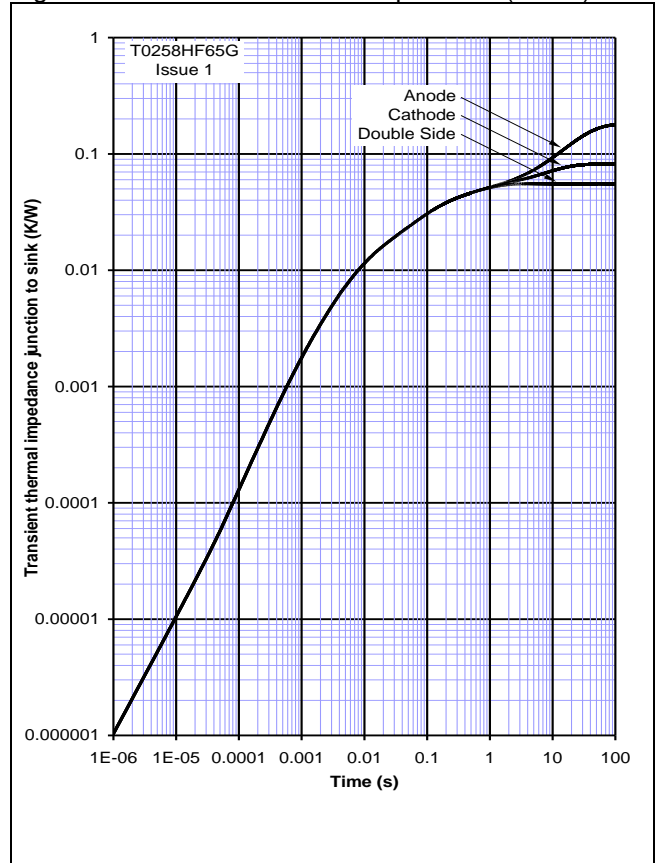
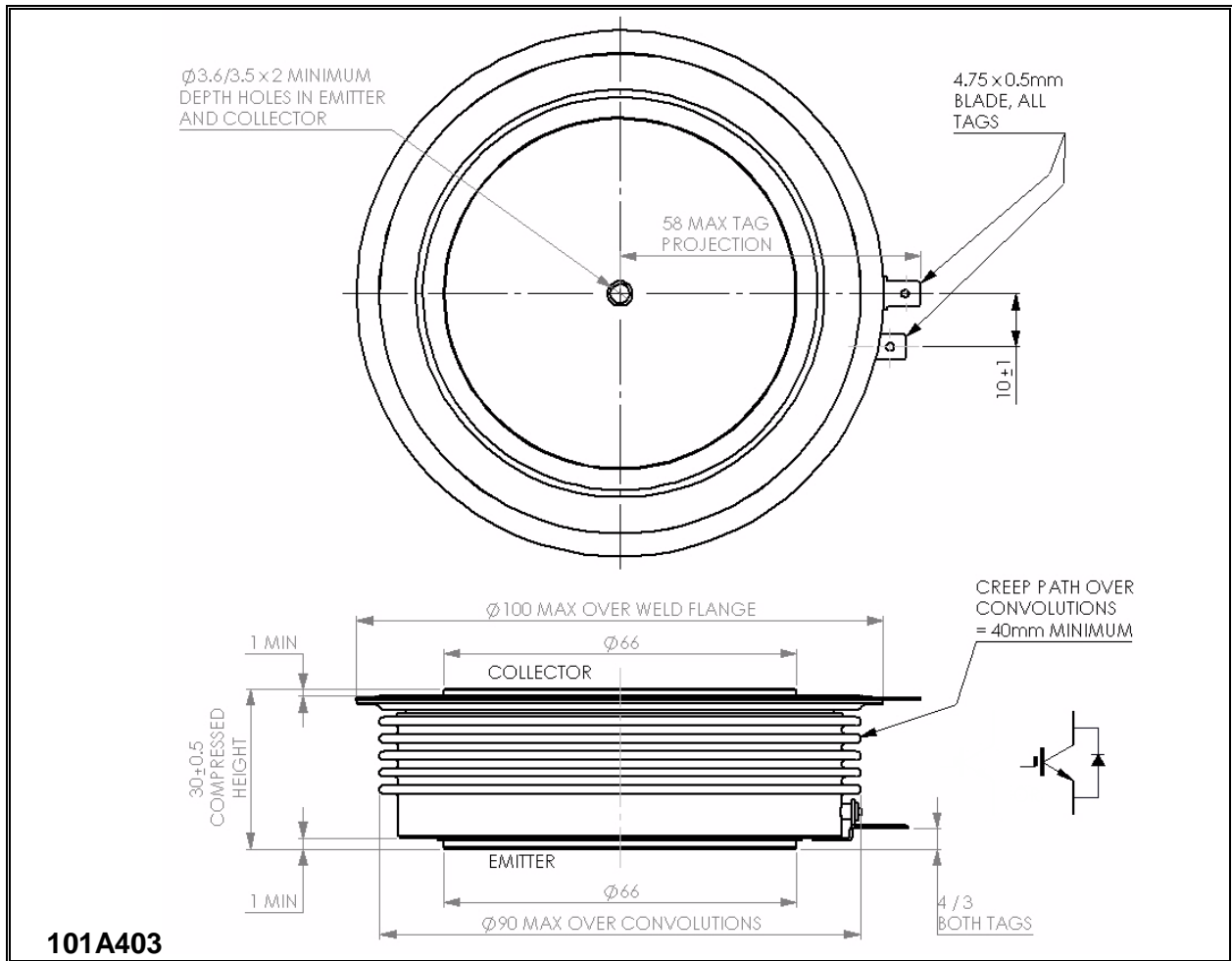


Figure 18 – Transient thermal impedance (Diode)



**Outline Drawing & Ordering Information**



**101A403**

**ORDERING INFORMATION**

(Please quote 10 digit code as below)

<b>T0258</b>	<b>HF</b>	<b>65</b>	<b>G</b>
Fixed type Code	Fixed Outline Code	Voltage Grade V <sub>CES</sub> /100 65	Fixed format code

Typical order code: T0258HF65G (V<sub>CES</sub> = 6500V)

**IXYS Semiconductor GmbH**  
Edisonstraße 15  
D-68623 Lampertheim  
Tel: +49 6206 503-0  
Fax: +49 6206 503-627  
E-mail: [marcom@ixys.de](mailto:marcom@ixys.de)



**IXYS UK Westcode Ltd**  
Langley Park Way, Langley Park,  
Chippenham, Wiltshire, SN15 1GE.  
Tel: +44 (0)1249 444524  
Fax: +44 (0)1249 659448  
E-mail: [sales@ixysuk.com](mailto:sales@ixysuk.com)

**IXYS Corporation**  
1590 Buckeye Drive  
Milpitas CA 95035-7418  
Tel: +1 (408) 457 9000  
Fax: +1 (408) 496 0670  
E-mail: [sales@ixys.net](mailto:sales@ixys.net)

[www.ixysuk.com](http://www.ixysuk.com)

[www.ixys.net](http://www.ixys.net)

**IXYS Long Beach**  
IXYS Long Beach, Inc  
2500 Mira Mar Ave, Long Beach  
CA 90815  
Tel: +1 (562) 296 6584  
Fax: +1 (562) 296 6585  
E-mail: [service@ixyslongbeach.com](mailto:service@ixyslongbeach.com)

The information contained herein is confidential and is protected by Copyright. The information may not be used or disclosed except with the written permission of and in the manner permitted by the proprietors IXYS UK Westcode Ltd.

© IXYS UK Westcode Ltd.

In the interest of product improvement, IXYS UK Westcode Ltd reserves the right to change specifications at any time without prior notice.

Devices with a suffix code (2-letter, 3-letter or letter/digit/letter combination) added to their generic code are not necessarily subject to the conditions and limits contained in this report.





---

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).